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A New Method To Accelerate Tissue and Wound Healing Rates and Reduce Swelling and Scar Formation

Tech ID: 19823 / UC Case 2010-084-0

BACKGROUND

Skin wounds are today typically treated with surface antibiotics and many different forms of bandages enriched with antibiotics and growth factors. There are numerous wound healing agents currently being used today.

TECHNOLOGY DESCRIPTION

UC San Diego inventors have come up with a novel approach to accelerate wound healing using a non-traditional pathway for treatment. At skin closure sites, the invention—compared to an untreated controls—produces reduced redness, swelling, exudates amount, tissue indurations, and scab formation around the incision site.

The invention is based on direct observations in rodent experiments involving skin wound closures. The exact rates of wound healing achieved by this method, as compared to control or other treatments, will be determined in experiments that are planned in the near future. Some preliminary unpublished results are available

PATENT STATUS

United States Of America Issued Patent 8,841,258 09/23/2014 2010-084	Country	Туре	Number	Dated	Case
	United States Of America	Issued Patent	8,841,258	09/23/2014	2010-084



INVENTORS

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OTHER INFORMATION

KEYWORDS

wound healing

CATEGORIZED AS

Medical

Disease: Dermatology

RELATED CASES

2010-084-0

ADDITIONAL TECHNOLOGIES BY THESE INVENTORS

- Microarray for High Throughput Detection of Enzymatic Activity
- ▶ Novel Method for Accelerating Alimentary Tract Recovery in Post Abdominal Surgeries

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